MOSFET - N-Channel Shielded Gate PowerTrench®

150 V, 10.9 mΩ, 74.3 A

NTP011N15MC

Features

- Shielded Gate MOSFET Technology
- Max $R_{DS(on)} = 10.9 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 41 \text{ A}$
- 50% Lower Qrr than other MOSFET Suppliers
- Lowers Switching Noise/EMI
- 100% UIL Tested
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parar	Symbol	Value	Unit		
Drain-to-Source Voltag	V_{DSS}	150	٧		
Gate-to-Source Voltage	Э		V _{GS}	±20	٧
Continuous Drain Current R _{θJC} (Note 2)	Steady State T _C = 25°C -		I _D	74.3	Α
Power Dissipation $R_{\theta JC}$ (Note 2)			P _D	136.4	W
Continuous Drain Current R _{0JA} (Notes 1, 2)	Steady State T _A = 25°C		I _D	9.8	Α
Power Dissipation R _{θJA} (Notes 1, 2)	State		P _D	2.4	W
Pulsed Drain Current	T _C = 25°	C, t _p = 100 μs	I _{DM}	374	Α
Operating Junction and Range	T _J , T _{stg}	-55 to +175	°C		
Single Pulse Drain-to-S Energy (I _L = 14 A _{pk} , L =	E _{AS}	294	mJ		
Lead Temperature for S (1/8" from case for 10 s)	TL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

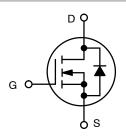
- 1. Surface-mounted on FR4 board using a 1 in2, 2 oz. Cu pad.
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.



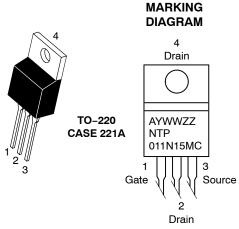
ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	V _{(BR)DSS} R _{DS(ON)} MAX	
150 V	10.9 mΩ @ 10 V	74.3 A



N-CHANNEL MOSFET



NTP011N15MC = Specific Device Code

A = Assembly Location

Y = Year
WW = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NTP011N15MC	TO-220 (Pb-Free)	800 / Tube

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{ hetaJC}$	1.1	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{ hetaJA}$	62.5	

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		150			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /	I _D = 250 μA, ref to 25°C			83		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 120 V	T _J = 25°C			1.0	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	= ±20 V			±100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$: 223 μA	2.5		4.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = 223 μA, ref	to 25°C		-8.5		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D	= 41 A		8.7	10.9	
		V _{GS} = 8 V, I _D	= 20 A		9.3	12.6	mΩ
Forward Transconductance	9FS	V _{DS} = 10 V, I _D	= 41 A		85		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE					•	
Input Capacitance	C _{ISS}			2810			
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MHz		840		pF	
Reverse Transfer Capacitance	C _{RSS}			14			
Gate-Resistance	R_{G}				0.8	1.6	Ω
Total Gate Charge	Q _{G(TOT)}			37		nC	
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 75 V; I _D = 41 A			9.1		
Gate-to-Source Charge	Q _{GS}				15		
Gate-to-Drain Charge	Q_{GD}				6.5		1
Plateau Voltage	V_{GP}	1			5.4		V
Output Charge	Q _{OSS}	V _{DD} = 75 V, V _G	iS = 0 V		95		nC
SWITCHING CHARACTERISTICS (Note 3)							
Turn-On Delay Time	t _{d(ON)}				19		
Rise Time	t _r	V _{GS} = 10 V, V _{DC}	= 75 V,		14		
Turn-Off Delay Time	t _{d(OFF)}	$V_{GS} = 10 \text{ V}, V_{DD} = 75 \text{ V},$ $I_{D} = 41 \text{ A}, R_{G} = 4.7 \Omega$			28		ns ns
Fall Time	t _f			5.1			
DRAIN-SOURCE DIODE CHARACTERISTIC	s						
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V, I _S = 41 A	T _J = 25°C		0.92	1.2	V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, V _{DD}	= 75 V		49		ns
Reverse Recovery Charge	Q _{RR}	$dI_S/dt = 300 A/\mu s$,			210		nC
Reverse Recovery Time	t _{RR}	VGe = 0 V. VDD	= 75 V		36		ns
Reverse Recovery Charge	Q _{RR}	$V_{GS} = 0 \text{ V}, V_{DD} = 75 \text{ V}$ $dI_S/dt = 1000 \text{ A}/\mu\text{s}, I_S = 41 \text{ A}$			421		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

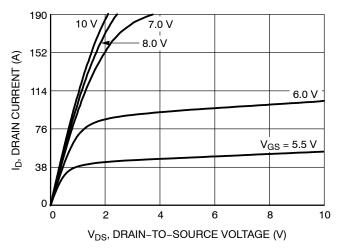


Figure 1. On-Region Characteristics

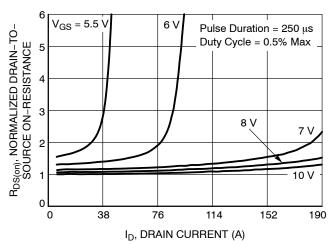


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

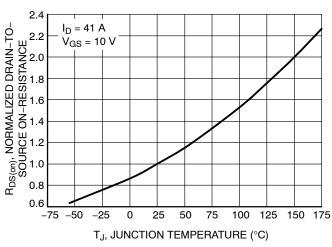


Figure 3. Normalized On-Resistance vs. Junction Temperature

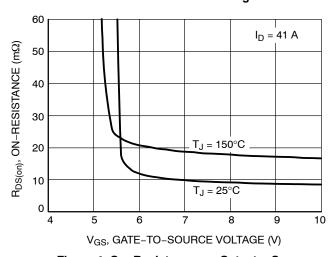


Figure 4. On-Resistance vs. Gate-to-Source Voltage

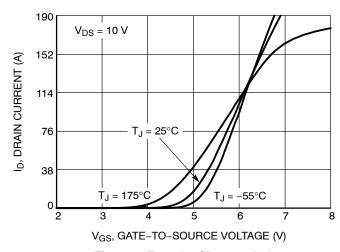


Figure 5. Transfer Characteristics

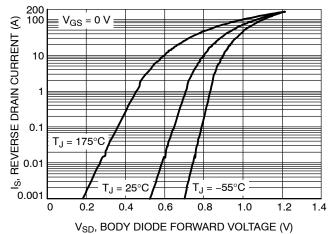


Figure 6. Source-to-Drain Diode Forward Voltage vs. Source Current

TYPICAL CHARACTERISTICS

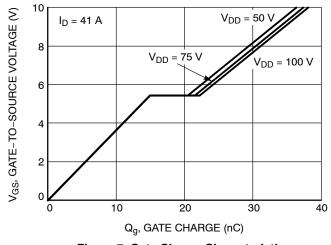


Figure 7. Gate Charge Characteristics

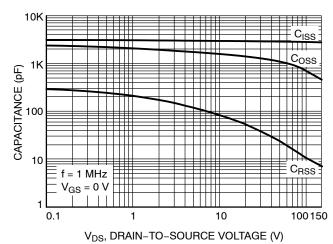


Figure 8. Capacitance vs. Drain-to-Source Voltage

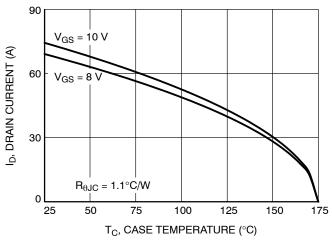


Figure 9. Drain Current vs. Case Temperature

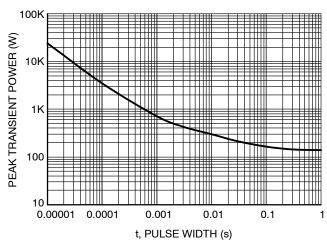


Figure 10. Peak Power

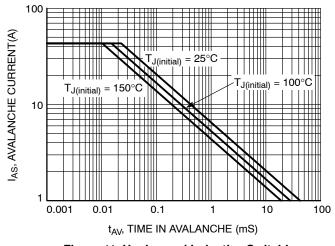


Figure 11. Unclamped Inductive Switching Capability

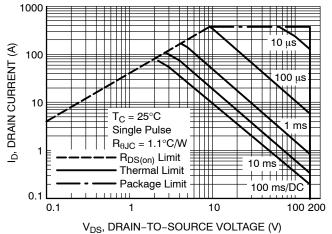


Figure 12. Forward Bias Safe Operating Area

TYPICAL CHARACTERISTICS

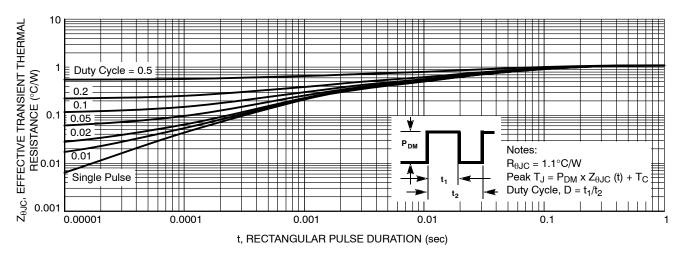
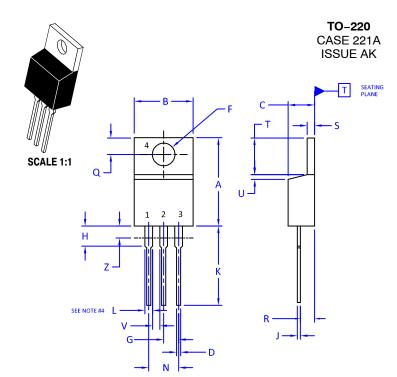


Figure 13. Transient Thermal Impedance





DATE 13 JAN 2022

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCHES		MILLIMI	ETERS
DIM	MIN.	MAX.	MIN.	MAX.
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.60	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
К	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.41
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

STYLE 1: PIN 1. 2. 3. 4.	COLLECTOR EMITTER	STYLE 2: PIN 1. 2. 3. 4.	COLLECTOR	STYLE 3: PIN 1. 2. 3. 4.	ANODE	2. 3.	MAIN TERMINAL 1 MAIN TERMINAL 2 GATE MAIN TERMINAL 2
STYLE 5: PIN 1. 2. 3. 4.	DRAIN SOURCE	2. 3.	ANODE CATHODE ANODE CATHODE	STYLE 7: PIN 1. 2. 3. 4.	ANODE	2. 3.	CATHODE ANODE EXTERNAL TRIP/DELAY ANODE
STYLE 9: PIN 1. 2. 3. 4.		STYLE 10: PIN 1. 2. 3. 4.	GATE	STYLE 11: PIN 1. 2. 3. 4.	DRAIN	STYLE 12: PIN 1. 2. 3. 4.	

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